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Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	8MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	8KB (4K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17lc43t-08i-pt

PIC17C4X

TABLE 1-1: PIC17CXX FAMILY OF DEVICES

Features		PIC17C42	PIC17CR42	PIC17C42A	PIC17C43	PIC17CR43	PIC17C44
Maximum Frequency of Operation		25 MHz	33 MHz	33 MHz	33 MHz	33 MHz	33 MHz
Operating Voltage Range		4.5 - 5.5V	2.5 - 6.0V	2.5 - 6.0V	2.5 - 6.0V	2.5 - 6.0V	2.5 - 6.0V
Program Memory x16	(EPROM)	2K	-	2K	4K	-	8K
	(ROM)	-	2K	-	-	4K	-
Data Memory (bytes)		232	232	232	454	454	454
Hardware Multiplier (8 x 8)		-	Yes	Yes	Yes	Yes	Yes
Timer0 (16-bit + 8-bit postscaler)		Yes	Yes	Yes	Yes	Yes	Yes
Timer1 (8-bit)		Yes	Yes	Yes	Yes	Yes	Yes
Timer2 (8-bit)		Yes	Yes	Yes	Yes	Yes	Yes
Timer3 (16-bit)		Yes	Yes	Yes	Yes	Yes	Yes
Capture inputs (16-bit)		2	2	2	2	2	2
PWM outputs (up to 10-bit)		2	2	2	2	2	2
USART/SCI		Yes	Yes	Yes	Yes	Yes	Yes
Power-on Reset		Yes	Yes	Yes	Yes	Yes	Yes
Watchdog Timer		Yes	Yes	Yes	Yes	Yes	Yes
External Interrupts		Yes	Yes	Yes	Yes	Yes	Yes
Interrupt Sources		11	11	11	11	11	11
Program Memory Code Protect		Yes	Yes	Yes	Yes	Yes	Yes
I/O Pins		33	33	33	33	33	33
I/O High Current Capability	Source	25 mA	25 mA	25 mA	25 mA	25 mA	25 mA
	Sink	25 mA ⁽¹⁾	25 mA ⁽¹⁾	25 mA ⁽¹⁾	25 mA ⁽¹⁾	25 mA ⁽¹⁾	25 mA ⁽¹⁾
Package Types		40-pin DIP 44-pin PLCC 44-pin MQFP	40-pin DIP 44-pin PLCC 44-pin MQFP 44-pin TQFP	40-pin DIP 44-pin PLCC 44-pin MQFP 44-pin TQFP	40-pin DIP 44-pin PLCC 44-pin MQFP 44-pin TQFP	40-pin DIP 44-pin PLCC 44-pin MQFP 44-pin TQFP	40-pin DIP 44-pin PLCC 44-pin MQFP 44-pin TQFP

Note 1: Pins RA2 and RA3 can sink up to 60 mA.

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC17C4X can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC17C4X uses a modified Harvard architecture. This architecture has the program and data accessed from separate memories. So the device has a program memory bus and a data memory bus. This improves bandwidth over traditional von Neumann architecture, where program and data are fetched from the same memory (accesses over the same bus). Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. PIC17C4X opcodes are 16-bits wide, enabling single word instructions. The full 16-bit wide program memory bus fetches a 16-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions execute in a single cycle (121 ns @ 33 MHz), except for program branches and two special instructions that transfer data between program and data memory.

The PIC17C4X can address up to 64K x 16 of program memory space.

The **PIC17C42** and **PIC17C42A** integrate 2K x 16 of EPROM program memory on-chip, while the **PIC17CR42** has 2K x 16 of ROM program memory on-chip.

The **PIC17C43** integrates 4K x 16 of EPROM program memory, while the **PIC17CR43** has 4K x 16 of ROM program memory.

The **PIC17C44** integrates 8K x 16 EPROM program memory.

Program execution can be internal only (microcontroller or protected microcontroller mode), external only (microprocessor mode) or both (extended microcontroller mode). Extended microcontroller mode does not allow code protection.

The PIC17CXX can directly or indirectly address its register files or data memory. All special function registers, including the Program Counter (PC) and Working Register (WREG), are mapped in the data memory. The PIC17CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC17CXX simple yet efficient. In addition, the learning curve is reduced significantly.

One of the PIC17CXX family architectural enhancements from the PIC16CXX family allows two file registers to be used in some two operand instructions. This allows data to be moved directly between two registers without going through the WREG register. This increases performance and decreases program memory usage.

The PIC17CXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift, and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature.

The WREG register is an 8-bit working register used for ALU operations.

All PIC17C4X devices (except the PIC17C42) have an 8 x 8 hardware multiplier. This multiplier generates a 16-bit result in a single cycle.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the **SUBLW** and **SUBWF** instructions for examples.

Although the ALU does not perform signed arithmetic, the Overflow bit (OV) can be used to implement signed math. Signed arithmetic is comprised of a magnitude and a sign bit. The overflow bit indicates if the magnitude overflows and causes the sign bit to change state. Signed math can have greater than 7-bit values (magnitude), if more than one byte is used. The use of the overflow bit only operates on bit6 (MSb of magnitude) and bit7 (sign bit) of the value in the ALU. That is, the overflow bit is not useful if trying to implement signed math where the magnitude, for example, is 11-bits. If the signed math values are greater than 7-bits (15-, 24- or 31-bit), the algorithm must ensure that the low order bytes ignore the overflow status bit.

Care should be taken when adding and subtracting signed numbers to ensure that the correct operation is executed. Example 3-1 shows an item that must be taken into account when doing signed arithmetic on an ALU which operates as an unsigned machine.

EXAMPLE 3-1: SIGNED MATH

Hex Value	Signed Value Math	Unsigned Value Math
FFh	-127	255
+ 01h	+ 1	+ 1
= ?	= -126 (FEh)	= 0 (00h); Carry bit = 1

Signed math requires the result in REG to be FEh (-126). This would be accomplished by subtracting one as opposed to adding one.

Simplified block diagrams are shown in Figure 3-1 and Figure 3-2. The descriptions of the device pins are listed in Table 3-1.

FIGURE 4-2: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ TIED TO V_{DD})

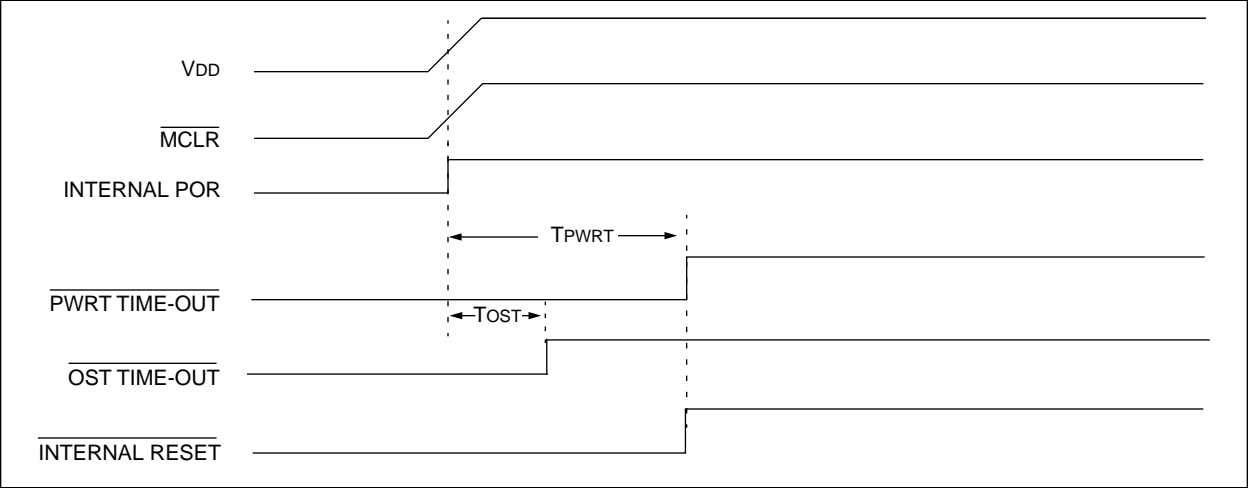


FIGURE 4-3: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD})

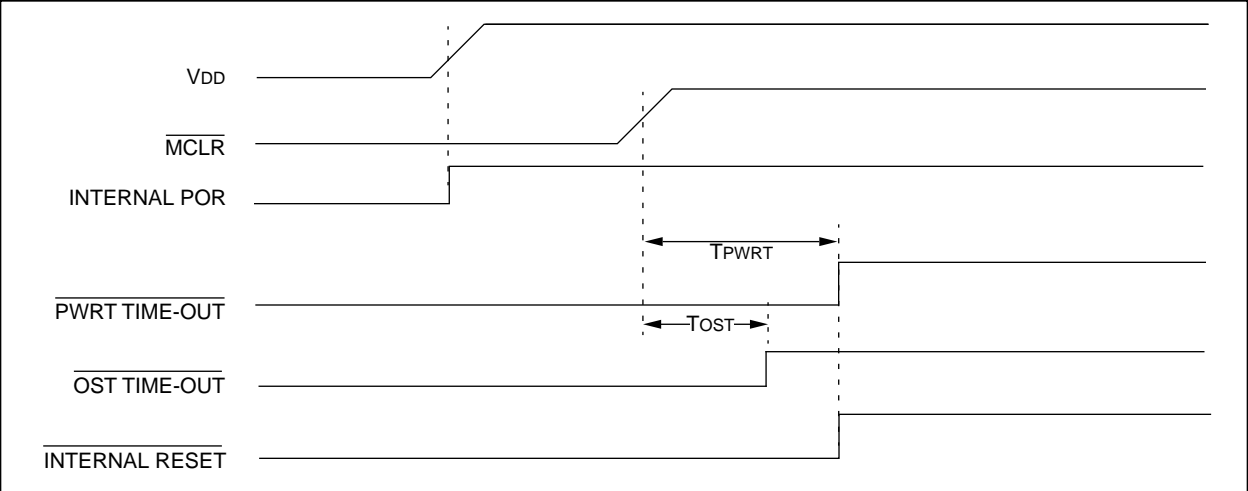


FIGURE 4-4: SLOW RISE TIME ($\overline{\text{MCLR}}$ TIED TO V_{DD})

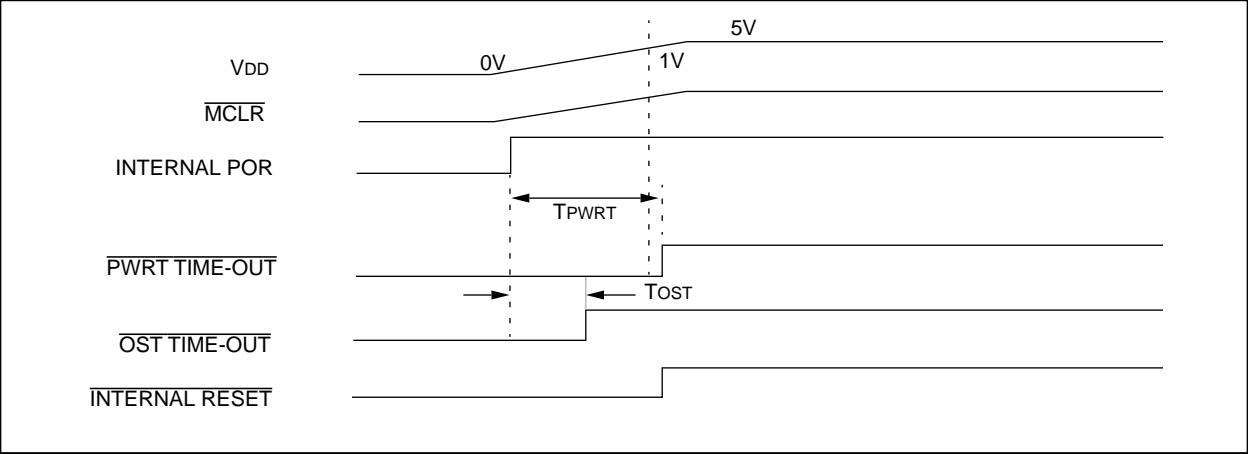


TABLE 6-3: SPECIAL FUNCTION REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (3)
Unbanked											
00h	INDF0	Uses contents of FSR0 to address data memory (not a physical register)								---- --	---- --
01h	FSR0	Indirect data memory address pointer 0								xxxx xxxx	uuuu uuuu
02h	PCL	Low order 8-bits of PC								0000 0000	0000 0000
03h ⁽¹⁾	PCLATH	Holding register for upper 8-bits of PC								0000 0000	uuuu uuuu
04h	ALUSTA	FS3	FS2	FS1	FS0	OV	Z	DC	C	1111 xxxx	1111 uuuu
05h	T0STA	INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—	0000 000-	0000 000-
06h ⁽²⁾	CPUSTA	—	—	STKAV	GLINTD	T0	PD	—	—	--11 11--	--11 qq--
07h	INTSTA	PEIF	T0CKIF	T0IF	INTF	PEIE	T0CKIE	T0IE	INTE	0000 0000	0000 0000
08h	INDF1	Uses contents of FSR1 to address data memory (not a physical register)								---- --	---- --
09h	FSR1	Indirect data memory address pointer 1								xxxx xxxx	uuuu uuuu
0Ah	WREG	Working register								xxxx xxxx	uuuu uuuu
0Bh	TMR0L	TMR0 register; low byte								xxxx xxxx	uuuu uuuu
0Ch	TMR0H	TMR0 register; high byte								xxxx xxxx	uuuu uuuu
0Dh	TBLPTRL	Low byte of program memory table pointer								(4)	(4)
0Eh	TBLPTRH	High byte of program memory table pointer								(4)	(4)
0Fh	BSR	Bank select register								0000 0000	0000 0000
Bank 0											
10h	PORTA	RBP0	—	RA5	RA4	RA3	RA2	RA1/T0CKI	RA0/INT	0-xx xxxx	0-uu uuuu
11h	DDRB	Data direction register for PORTB								1111 1111	1111 1111
12h	PORTB	PORTB data latch								xxxx xxxx	uuuu uuuu
13h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
14h	RCREG	Serial port receive register								xxxx xxxx	uuuu uuuu
15h	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u
16h	TXREG	Serial port transmit register								xxxx xxxx	uuuu uuuu
17h	SPBRG	Baud rate generator register								xxxx xxxx	uuuu uuuu
Bank 1											
10h	DDRC	Data direction register for PORTC								1111 1111	1111 1111
11h	PORTC	RC7/AD7	RC6/AD6	RC5/AD5	RC4/AD4	RC3/AD3	RC2/AD2	RC1/AD1	RC0/AD0	xxxx xxxx	uuuu uuuu
12h	DDRD	Data direction register for PORTD								1111 1111	1111 1111
13h	PORTD	RD7/AD15	RD6/AD14	RD5/AD13	RD4/AD12	RD3/AD11	RD2/AD10	RD1/AD9	RD0/AD8	xxxx xxxx	uuuu uuuu
14h	DDRE	Data direction register for PORTE								---- -111	---- -111
15h	PORTE	—	—	—	—	—	RE2/W _R	RE1/O _E	RE0/ALE	---- -xxx	---- -uuu
16h	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
17h	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented read as '0', q - value depends on condition. Shaded cells are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for PC<15:8> whose contents are updated from or transferred to the upper byte of the program counter.

2: The T0 and PD status bits in CPUSTA are not affected by a MCLR reset.

3: Other (non power-up) resets include: external reset through MCLR and the Watchdog Timer Reset.

4: The following values are for both TBLPTRL and TBLPTRH:

All PIC17C4X devices (Power-on Reset 0000 0000) and (All other resets 0000 0000)
except the PIC17C42 (Power-on Reset xxxx xxxx) and (All other resets uuuu uuuu)

5: The PRODL and PRODH registers are not implemented on the PIC17C42.

7.2 Table Writes to External Memory

Table writes to external memory are always two-cycle instructions. The second cycle writes the data to the external memory location. The sequence of events for an external memory write are the same for an internal write.

Note: If an interrupt is pending or occurs during the TABLWT, the two cycle table write completes. The RA0/INT, TMR0, or T0CKI interrupt flag is automatically cleared or the pending peripheral interrupt is acknowledged.

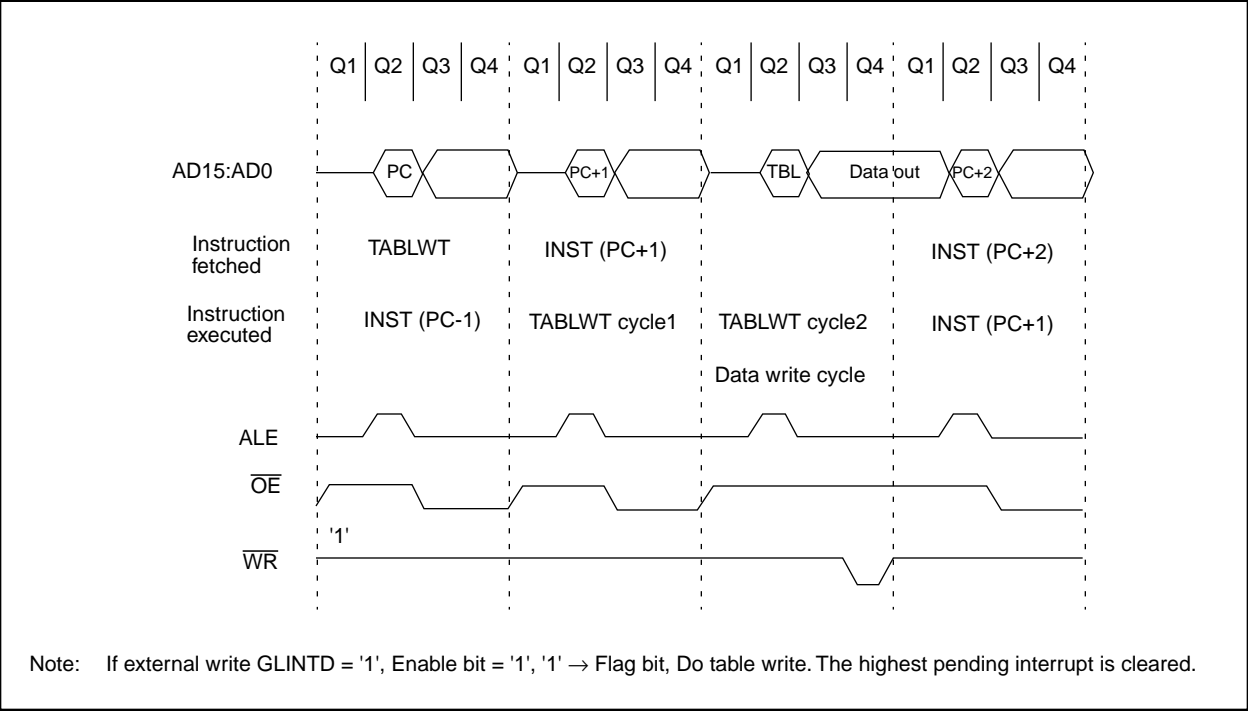
7.2.2 TABLE WRITE CODE

The “i” operand of the TABLWT instruction can specify that the value in the 16-bit TBLPTR register is automatically incremented for the next write. In Example 7-1, the TBLPTR register is not automatically incremented.

EXAMPLE 7-1: TABLE WRITE

```
CLRWDT           ; Clear WDT
MOVLW    HIGH (TBL_ADDR) ; Load the Table
MOVWF    TBLPTRH      ; address
MOVLW    LOW  (TBL_ADDR) ;
MOVWF    TBLPTRL      ;
MOVLW    HIGH (DATA)   ; Load HI byte
TLWT     1, WREG        ; in TABLATCH
MOVLW    LOW  (DATA)   ; Load LO byte
TABLWT   0,0,WREG       ; in TABLATCH
                        ; and write to
                        ; program memory
                        ; (Ext. SRAM)
```

FIGURE 7-5: TABLWT WRITE TIMING (EXTERNAL MEMORY)



9.0 I/O PORTS

The PIC17C4X devices have five I/O ports, PORTA through PORTE. PORTB through PORTE have a corresponding Data Direction Register (DDR), which is used to configure the port pins as inputs or outputs. These five ports are made up of 33 I/O pins. Some of these ports pins are multiplexed with alternate functions.

PORTC, PORTD, and PORTE are multiplexed with the system bus. These pins are configured as the system bus when the device's configuration bits are selected to Microprocessor or Extended Microcontroller modes. In the two other microcontroller modes, these pins are general purpose I/O.

PORTA and PORTB are multiplexed with the peripheral features of the device. These peripheral features are:

- Timer modules
- Capture module
- PWM module
- USART/SCI module
- External Interrupt pin

When some of these peripheral modules are turned on, the port pin will automatically configure to the alternate function. The modules that do this are:

- PWM module
- USART/SCI module

When a pin is automatically configured as an output by a peripheral module, the pins data direction (DDR) bit is unknown. After disabling the peripheral module, the user should re-initialize the DDR bit to the desired configuration.

The other peripheral modules (which require an input) must have their data direction bit configured appropriately.

Note: A pin that is a peripheral input, can be configured as an output (DDRx<y> is cleared). The peripheral events will be determined by the action output on the port pin.

9.1 PORTA Register

PORTA is a 6-bit wide latch. PORTA does not have a corresponding Data Direction Register (DDR).

Reading PORTA reads the status of the pins.

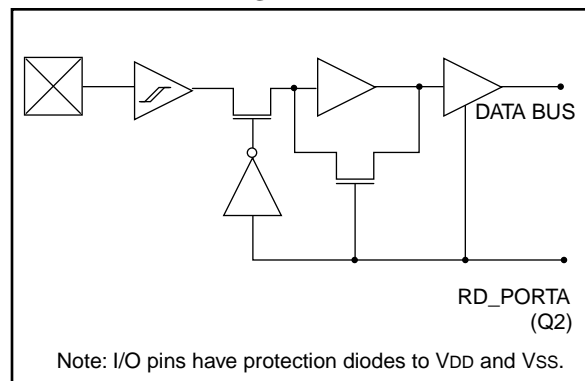
The RA1 pin is multiplexed with TMR0 clock input, and RA4 and RA5 are multiplexed with the USART functions. The control of RA4 and RA5 as outputs is automatically configured by the USART module.

9.1.1 USING RA2, RA3 AS OUTPUTS

The RA2 and RA3 pins are open drain outputs. To use the RA2 or the RA3 pin(s) as output(s), simply write to the PORTA register the desired value. A '0' will cause the pin to drive low, while a '1' will cause the pin to float (hi-impedance). An external pull-up resistor should be used to pull the pin high. Writes to PORTA will not affect the other pins.

Note: When using the RA2 or RA3 pin(s) as output(s), read-modify-write instructions (such as BCF, BSF, BTG) on PORTA are not recommended. Such operations read the port pins, do the desired operation, and then write this value to the data latch. This may inadvertently cause the RA2 or RA3 pins to switch from input to output (or vice-versa). It is recommended to use a shadow register for PORTA. Do the bit operations on this shadow register and then move it to PORTA.

FIGURE 9-1: RA0 AND RA1 BLOCK DIAGRAM



11.0 TIMER0

The Timer0 module consists of a 16-bit timer/counter, TMR0. The high byte is TMR0H and the low byte is TMR0L. A software programmable 8-bit prescaler makes an effective 24-bit overflow timer. The clock source is also software programmable as either the internal instruction clock or the RA1/T0CKI pin. The control bits for this module are in register T0STA (Figure 11-1).

FIGURE 11-1: T0STA REGISTER (ADDRESS: 05h, UNBANKED)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	U - 0
INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented, Read as '0'
-n = Value at POR reset

bit 7: **INTEDG:** RA0/INT Pin Interrupt Edge Select bit
This bit selects the edge upon which the interrupt is detected
1 = Rising edge of RA0/INT pin generates interrupt
0 = Falling edge of RA0/INT pin generates interrupt

bit 6: **T0SE:** Timer0 Clock Input Edge Select bit
This bit selects the edge upon which TMR0 will increment
When T0CS = 0
1 = Rising edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
0 = Falling edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
When T0CS = 1
Don't care

bit 5: **T0CS:** Timer0 Clock Source Select bit
This bit selects the clock source for TMR0.
1 = Internal instruction clock cycle (Tcy)
0 = T0CKI pin

bit 4-1: **PS3:PS0:** Timer0 Prescale Selection bits
These bits select the prescale value for TMR0.

PS3:PS0	Prescale Value
0000	1:1
0001	1:2
0010	1:4
0011	1:8
0100	1:16
0101	1:32
0110	1:64
0111	1:128
1xxx	1:256

bit 0: **Unimplemented:** Read as '0'

11.1 Timer0 Operation

When the T0CS (T0STA<5>) bit is set, TMR0 increments on the internal clock. When T0CS is clear, TMR0 increments on the external clock (RA1/T0CKI pin). The external clock edge can be configured in software. When the T0SE (T0STA<6>) bit is set, the timer will increment on the rising edge of the RA1/T0CKI pin. When T0SE is clear, the timer will increment on the falling edge of the RA1/T0CKI pin. The prescaler can be programmed to introduce a prescale of 1:1 to 1:256. The timer increments from 0000h to FFFFh and rolls over to 0000h. On overflow, the TMR0 Interrupt Flag bit (T0IF) is set. The TMR0 interrupt can be masked by clearing the corresponding TMR0 Interrupt Enable bit (T0IE). The TMR0 Interrupt Flag bit (T0IF) is automatically cleared when vectoring to the TMR0 interrupt vector.

11.2 Using Timer0 with External Clock

When the external clock input is used for Timer0, it is synchronized with the internal phase clocks. Figure 11-3 shows the synchronization of the external clock. This synchronization is done after the prescaler. The output of the prescaler (PSOUT) is sampled twice in every instruction cycle to detect a rising or a falling edge. The timing requirements for the external clock are detailed in the electrical specification section for the desired device.

11.2.1 DELAY FROM EXTERNAL CLOCK EDGE

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time TMR0 is actually incremented. Figure 11-3 shows that this delay is between 3TOSC and 7TOSC. Thus, for example, measuring the interval between two edges (e.g. period) will be accurate within $\pm 4TOSC$ (± 121 ns @ 33 MHz).

FIGURE 11-2: TIMER0 MODULE BLOCK DIAGRAM

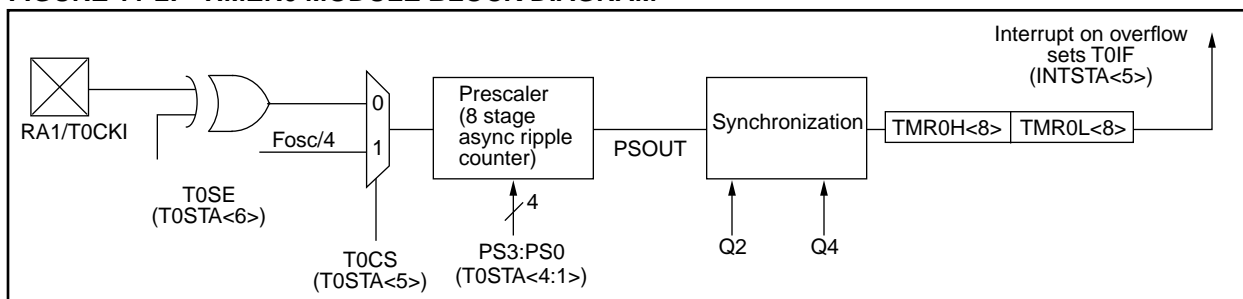
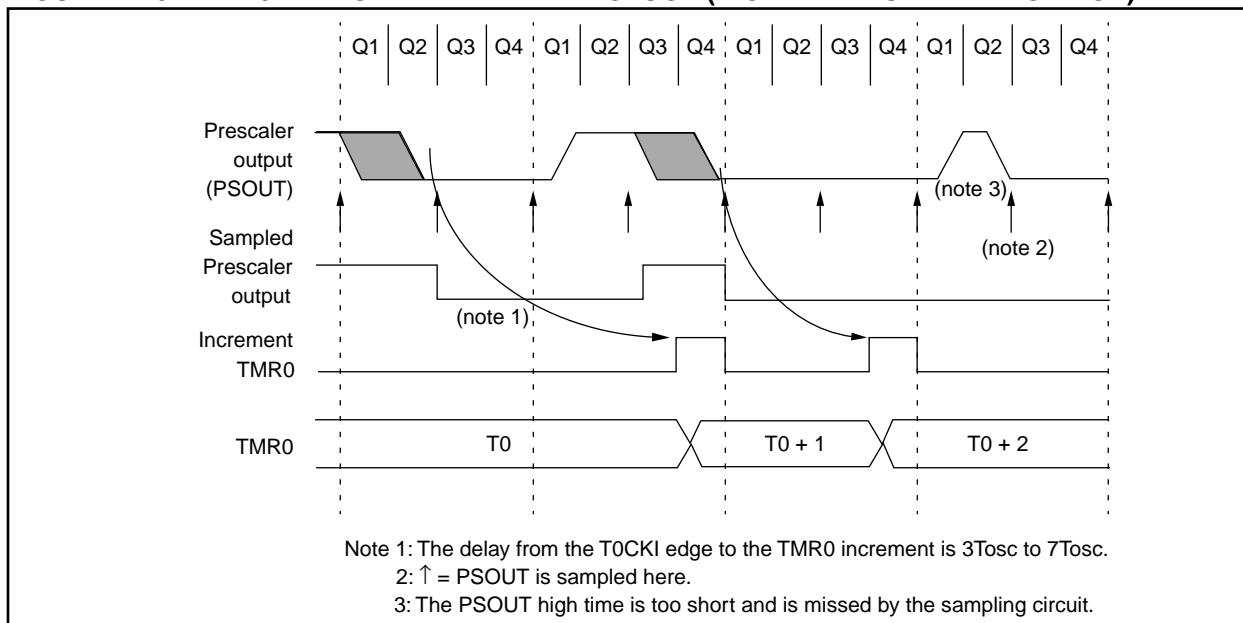


FIGURE 11-3: TMR0 TIMING WITH EXTERNAL CLOCK (INCREMENT ON FALLING EDGE)



12.0 TIMER1, TIMER2, TIMER3, PWMS AND CAPTURES

The PIC17C4X has a wealth of timers and time-based functions to ease the implementation of control applications. These time-base functions include two PWM outputs and two Capture inputs.

Timer1 and Timer2 are two 8-bit incrementing timers, each with a period register (PR1 and PR2 respectively) and separate overflow interrupt flags. Timer1 and Timer2 can operate either as timers (increment on internal Fosc/4 clock) or as counters (increment on falling edge of external clock on pin RB4/TCLK12). They are also software configurable to operate as a single 16-bit timer. These timers are also used as the time-base for the PWM (pulse width modulation) module.

Timer3 is a 16-bit timer/counter consisting of the TMR3H and TMR3L registers. This timer has four other associated registers. Two registers are used as a 16-bit period register or a 16-bit Capture1 register (PR3H/CA1H:PR3L/CA1L). The other two registers are strictly the Capture2 registers (CA2H:CA2L). Timer3 is the time-base for the two 16-bit captures.

TMR3 can be software configured to increment from the internal system clock or from an external signal on the RB5/TCLK3 pin.

Figure 12-1 and Figure 12-2 are the control registers for the operation of Timer1, Timer2, and Timer3, as well as PWM1, PWM2, Capture1, and Capture2.

FIGURE 12-1: TCON1 REGISTER (ADDRESS: 16h, BANK 3)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0
CA2ED1	CA2ED0	CA1ED1	CA1ED0	T16	TMR3CS	TMR2CS	TMR1CS
bit7							bit0
<p>bit 7-6: CA2ED1:CA2ED0: Capture2 Mode Select bits 00 = Capture on every falling edge 01 = Capture on every rising edge 10 = Capture on every 4th rising edge 11 = Capture on every 16th rising edge</p> <p>bit 5-4: CA1ED1:CA1ED0: Capture1 Mode Select bits 00 = Capture on every falling edge 01 = Capture on every rising edge 10 = Capture on every 4th rising edge 11 = Capture on every 16th rising edge</p> <p>bit 3: T16: Timer1:Timer2 Mode Select bit 1 = Timer1 and Timer2 form a 16-bit timer 0 = Timer1 and Timer2 are two 8-bit timers</p> <p>bit 2: TMR3CS: Timer3 Clock Source Select bit 1 = TMR3 increments off the falling edge of the RB5/TCLK3 pin 0 = TMR3 increments off the internal clock</p> <p>bit 1: TMR2CS: Timer2 Clock Source Select bit 1 = TMR2 increments off the falling edge of the RB4/TCLK12 pin 0 = TMR2 increments off the internal clock</p> <p>bit 0: TMR1CS: Timer1 Clock Source Select bit 1 = TMR1 increments off the falling edge of the RB4/TCLK12 pin 0 = TMR1 increments off the internal clock</p>							

R = Readable bit
 W = Writable bit
 -n = Value at POR reset

INCF Increment f

Syntax: [*label*] INCF f,d

Operands: $0 \leq f \leq 255$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{dest})$

Status Affected: OV, C, DC, Z

Encoding:

0001	010d	ffff	ffff
------	------	------	------

Description: The contents of register 'f' are incremented. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example: INCF CNT, 1

Before Instruction

CNT = 0xFF
 Z = 0
 C = ?

After Instruction

CNT = 0x00
 Z = 1
 C = 1

INCFSZ Increment f, skip if 0

Syntax: [*label*] INCFSZ f,d

Operands: $0 \leq f \leq 255$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{dest})$
 skip if result = 0

Status Affected: None

Encoding:

0001	111d	ffff	ffff
------	------	------	------

Description: The contents of register 'f' are incremented. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.

If the result is 0, the next instruction, which is already fetched, is discarded, and an NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

If skip:

Q1	Q2	Q3	Q4
Forced NOP	NOP	Execute	NOP

Example: HERE INCFSZ CNT, 1
 NZERO :
 ZERO :

Before Instruction

PC = Address (HERE)

After Instruction

CNT = CNT + 1
 If CNT = 0;
 PC = Address (ZERO)
 If CNT \neq 0;
 PC = Address (NZERO)

SLEEP		Enter SLEEP mode						
Syntax:	[<i>label</i>] SLEEP							
Operands:	None							
Operation:	00h → WDT; 0 → WDT postscaler; 1 → \overline{TO} ; 0 → \overline{PD}							
Status Affected:	\overline{TO} , \overline{PD}							
Encoding:	<table border="1"><tr><td>0000</td><td>0000</td><td>0000</td><td>0011</td></tr></table>				0000	0000	0000	0011
0000	0000	0000	0011					
Description:	<p>The power down status bit (\overline{PD}) is cleared. The time-out status bit (\overline{TO}) is set. Watchdog Timer and its prescaler are cleared.</p> <p>The processor is put into SLEEP mode with the oscillator stopped.</p>							
Words:	1							
Cycles:	1							

Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register PCLATH	Execute	NOP

Example: SLEEP

Before Instruction

\overline{TO} = ?

\overline{PD} = ?

After Instruction

\overline{TO} = 1 †

\overline{PD} = 0

† If WDT causes wake-up, this bit is cleared

SUBLW	Subtract WREG from Literal				
Syntax:	[<i>label</i>] SUBLW k				
Operands:	$0 \leq k \leq 255$				
Operation:	$k - (WREG) \rightarrow (WREG)$				
Status Affected:	OV, C, DC, Z				
Encoding:	<table><tr><td>1011</td><td>0010</td><td>kkkk</td><td>kkkk</td></tr></table>	1011	0010	kkkk	kkkk
1011	0010	kkkk	kkkk		
Description:	WREG is subtracted from the eight bit literal 'k'. The result is placed in WREG.				
Words:	1				
Cycles:	1				

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Execute	Write to WREG

Example 1: SUBLW 0x02

Before Instruction

WREG = 1

C = ?

After Instruction

WREG = 1

C = 1 ; result is positive

Z = 0

Example 2:

Before Instruction

WREG = 2

C = ?

After Instruction

WREG = 0

C = 1 ; result is zero

Z = 1

Example 3:

Before Instruction

WREG = 3

C = ?

After Instruction

WREG = FF ; (2's complement)

C = 0 ; result is negative

Z = 1

XORLW		Exclusive OR Literal with WREG							
Syntax:	[<i>label</i>] XORLW k								
Operands:	0 ≤ k ≤ 255								
Operation:	(WREG) .XOR. k → (WREG)								
Status Affected:	Z								
Encoding:	<table><tr><td>1011</td><td>0100</td><td>kkkk</td><td>kkkk</td></tr></table>					1011	0100	kkkk	kkkk
1011	0100	kkkk	kkkk						
Description:	The contents of WREG are XOR'ed with the 8-bit literal 'k'. The result is placed in WREG.								
Words:	1								
Cycles:	1								
Q Cycle Activity:									
	Q1	Q2	Q3	Q4					
	Decode	Read literal 'k'	Execute	Write to WREG					

Example: XORLW 0xAF

Before Instruction
WREG = 0xB5

After Instruction
WREG = 0x1A

XORWF		Exclusive OR WREG with f						
Syntax:	[<i>label</i>] XORWF f,d							
Operands:	0 ≤ f ≤ 255 d ∈ [0,1]							
Operation:	(WREG) .XOR. (f) → (dest)							
Status Affected:	Z							
Encoding:	<table border="1"><tr><td>0000</td><td>110d</td><td>ffff</td><td>ffff</td></tr></table>				0000	110d	ffff	ffff
0000	110d	ffff	ffff					
Description:	Exclusive OR the contents of WREG with register 'f'. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in the register 'f'.							
Words:	1							
Cycles:	1							
Q Cycle Activity:								
	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Execute	Write to destination				

Example: XORWF REG, 1

Before Instruction
REG = 0xAF
WREG = 0xB5

After Instruction
REG = 0x1A
WREG = 0xB5

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DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated)					
		Operating temperature					
		-40°C ≤ TA ≤ +40°C					
		Operating voltage VDD range as described in Section 17.1					
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
		Internal Program Memory Programming Specs (Note 4)					
D110	VPP	Voltage on $\overline{\text{MCLR}}$ /VPP pin	12.75	–	13.25	V	Note 5
D111	VDDP	Supply voltage during programming	4.75	5.0	5.25	V	
D112	IPP	Current into $\overline{\text{MCLR}}$ /VPP pin	–	25 ‡	50 ‡	mA	
D113	IDDP	Supply current during programming	–	–	30 ‡	mA	
D114	TPROG	Programming pulse width	10	100	1000	μs	Terminated via internal/external interrupt or a reset

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC17CXX devices be driven with external clock in RC mode.

2: The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

4: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in: PIC17CXX Programming Specifications (Literature number DS30139).

5: The $\overline{\text{MCLR}}$ /VPP pin may be kept in this range at times other than programming, but is not recommended.

6: For TTL buffers, the better of the two specifications may be used.

Note: When using the Table Write for internal programming, the device temperature must be less than 40°C.

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FIGURE 18-9: TYPICAL I_{PD} vs. V_{DD} WATCHDOG DISABLED 25°C

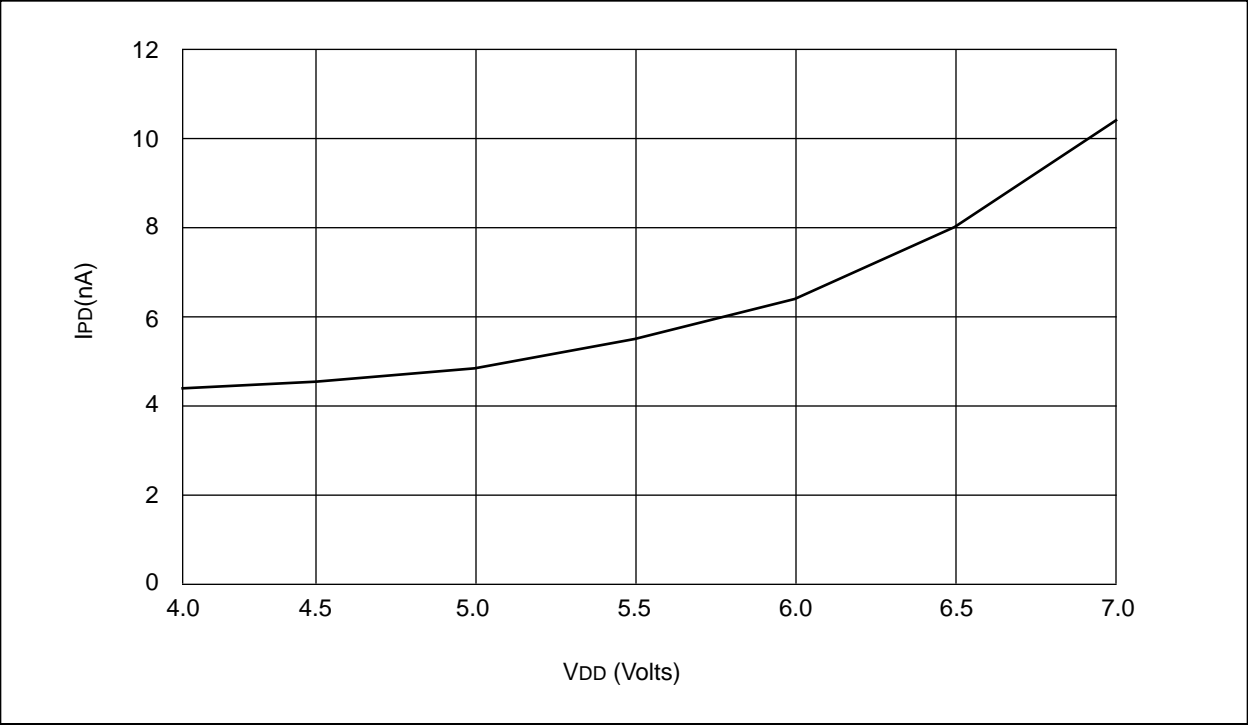


FIGURE 18-10: MAXIMUM I_{PD} vs. V_{DD} WATCHDOG DISABLED

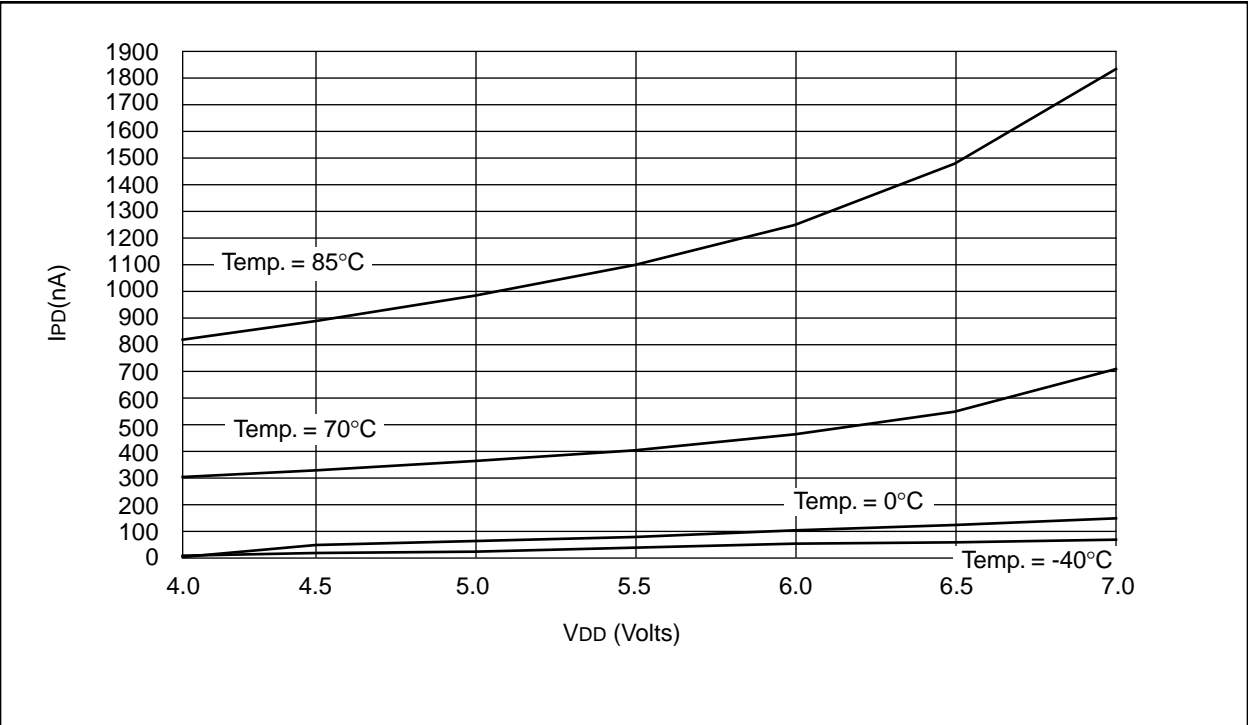


FIGURE 18-19: V_{IH} , V_{IL} of I/O PINS (SCHMITT TRIGGER) vs. V_{DD}

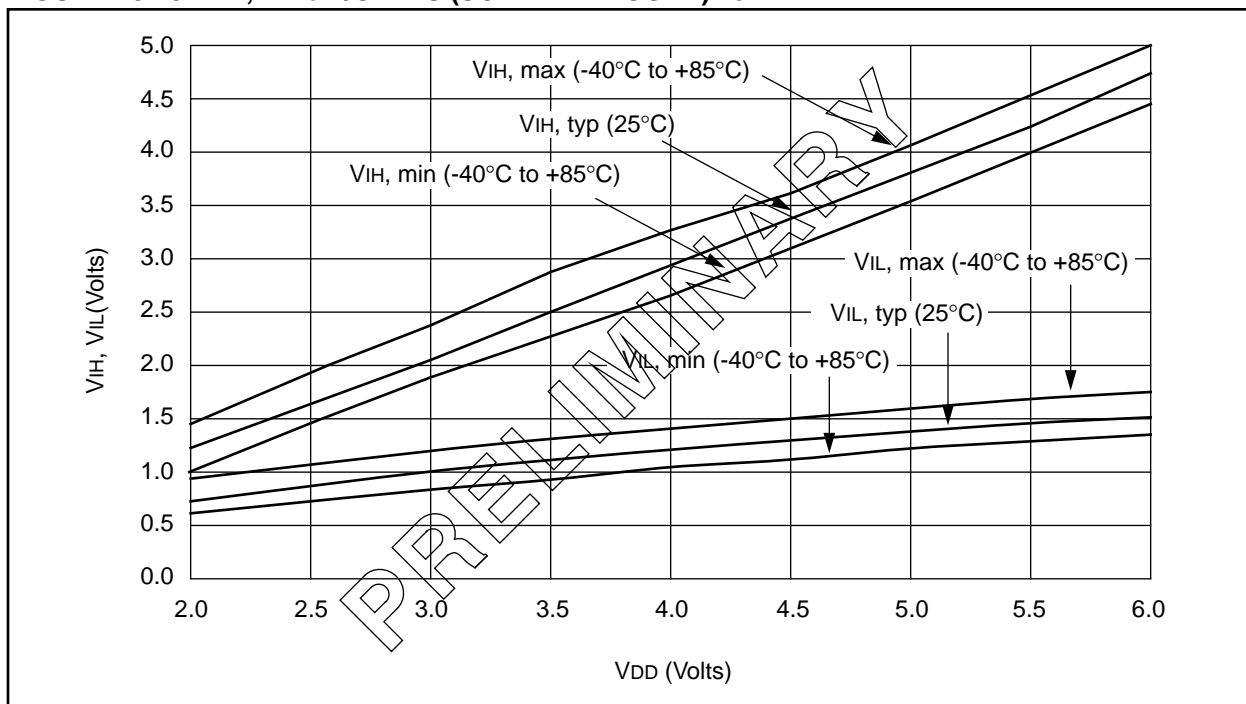
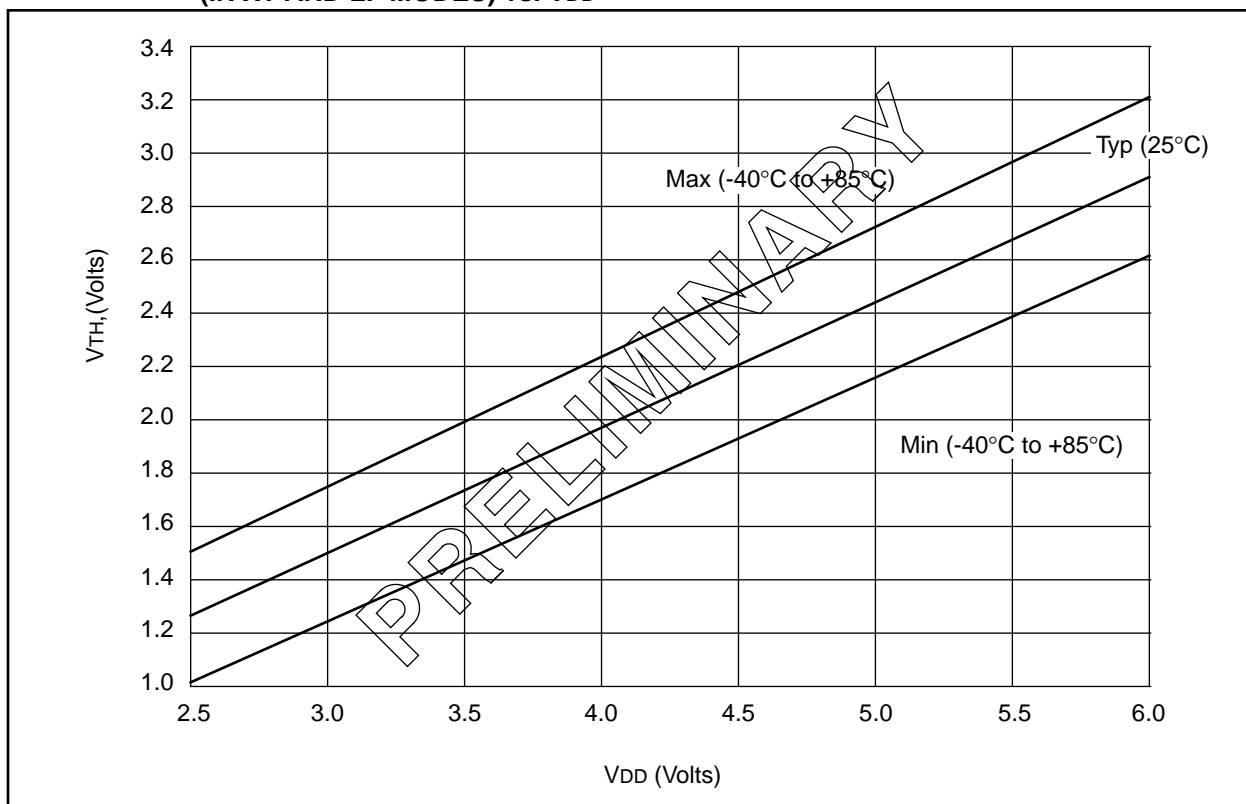


FIGURE 18-20: V_{TH} (INPUT THRESHOLD VOLTAGE) OF OSC1 INPUT (IN XT AND LF MODES) vs. V_{DD}



PIC17C4X

Applicable Devices 42 R42 42A 43 R43 44

FIGURE 19-11: MEMORY INTERFACE WRITE TIMING (NOT SUPPORTED IN PIC17LC4X DEVICES)

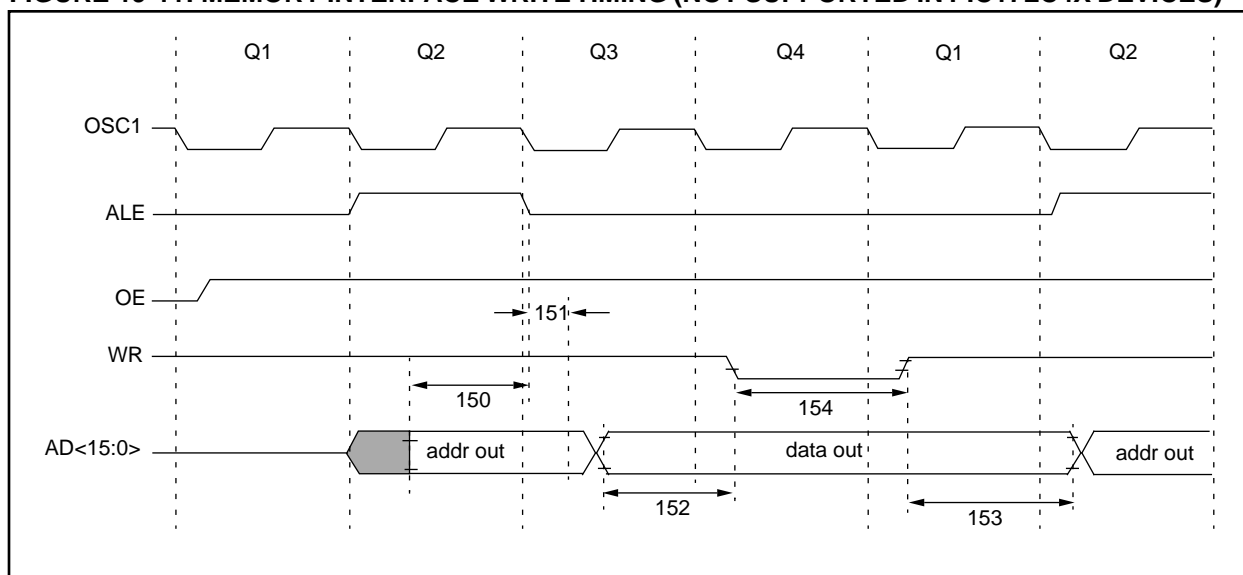


TABLE 19-11: MEMORY INTERFACE WRITE REQUIREMENTS (NOT SUPPORTED IN PIC17LC4X DEVICES)

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
150	TadV2aLL	AD<15:0> (address) valid to ALE↓ (address setup time)	0.25Tcy - 10	—	—	ns	
151	TaIL2adI	ALE↓ to address out invalid (address hold time)	0	—	—	ns	
152	TadV2wrL	Data out valid to WR↓ (data setup time)	0.25Tcy - 40	—	—	ns	
153	TwrH2adI	WR↑ to data out invalid (data hold time)	—	0.25Tcy §	—	ns	
154	TwrL	WR pulse width	—	0.25Tcy §	—	ns	

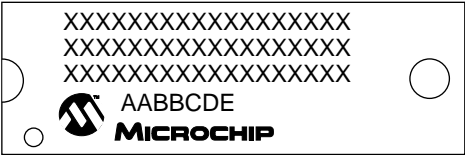
* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

21.6 Package Marking Information

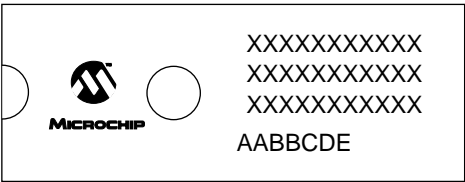
40-Lead PDIP/CERDIP



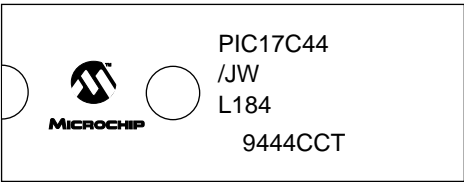
Example



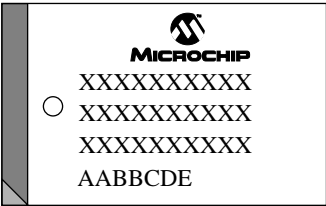
40 Lead CERDIP Windowed



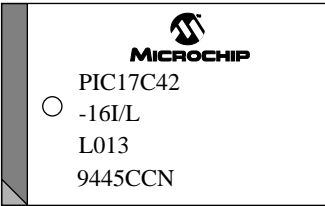
Example



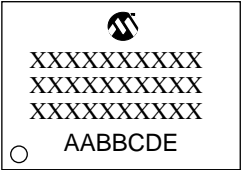
44-Lead PLCC



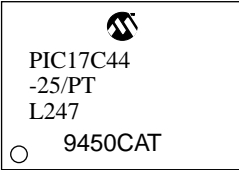
Example



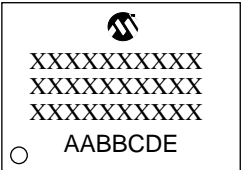
44-Lead MQFP



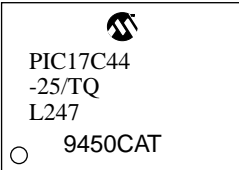
Example



44-Lead TQFP



Example



Legend: MM...M Microchip part number information
XX...X Customer specific information*
AA Year code (last 2 digits of calendar year)
BB Week code (week of January 1 is week '01')
C Facility code of the plant at which wafer is manufactured
C = Chandler, Arizona, U.S.A.,
S = Tempe, Arizona, U.S.A.
D Mask revision number
E Assembly code of the plant or country of origin in which part was assembled

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask rev#, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

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